

PRXS360HF12DFC1



Description

The PRXS360HF12DFC1 is a Half Bridge SiC MOSFET Power Module. It integrates high performance SiC MOSFET chips and SiC Diode designed for the applications such as Motor drives and Renewable energy.

Features

- 1200V/5.3m Ω ($V_{GS} = 15V$), 4.3 m Ω ($V_{GS} = 18V$)
- Low thermal resistance with Si₃N₄ AMB
- 175°C maximum junction temperature
- Zero Reverse Recovery from Diodes
- 62mm half bridge module

Applications

- Motor Drives
- Vehicle Fast Chargers
- Renewable energy
- UPS

Circuit Diagram

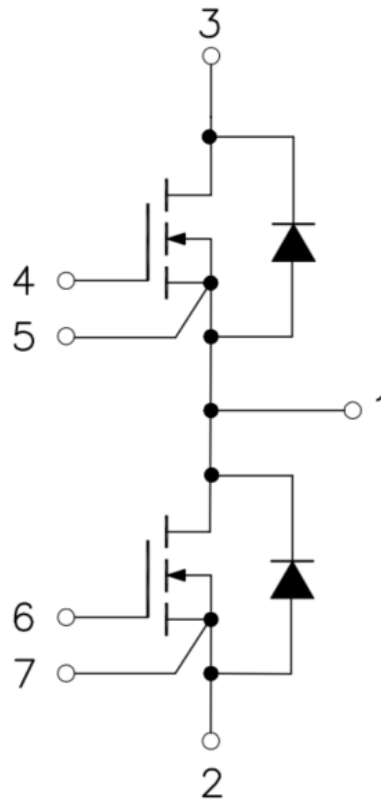


Figure 1. Out drawing & circuit diagram for PRXS360HF12DFC1

PRXS360HF12DFC1
1200V/360A Half Bridge SiC MOSFET Module

Pin Configuration and Marking Information

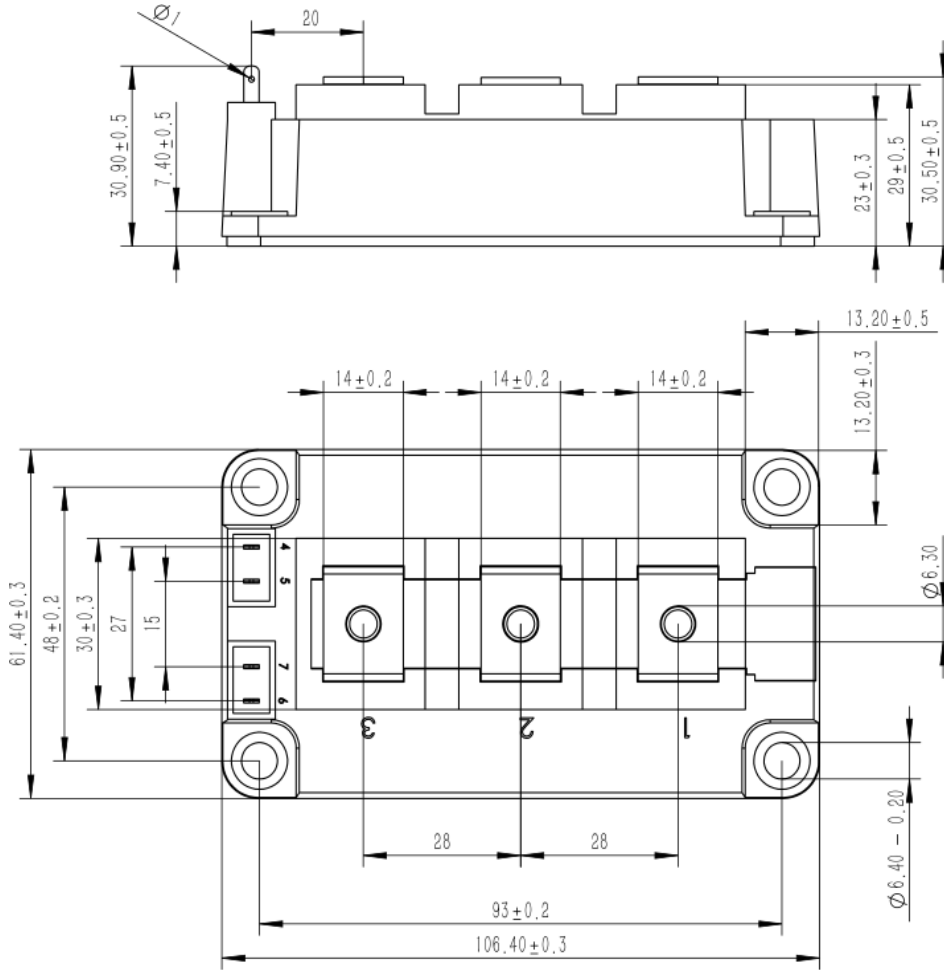


Figure 2. Pin configuration

Module

Parameter	Conditions	Value	Unit
Isolation Voltage	RMS, f =50Hz, t =1min	4.0	KV
Material of module baseplate	-	Cu	-
Creepage distance	terminal to heatsink terminal to terminal	14.5 10	mm
Clearance	terminal to heatsink terminal to terminal	12.5 10	mm
CTI	-	>400	-
Module lead resistance, terminals – chip	T _C =25°C	0.3	mΩ
Mounting torque for module mounting	M6	4 to 6	Nm
Weight	-	300	g

PRXS360HF12DFC1
1200V/360A Half Bridge SiC MOSFET Module

Maximum Ratings ($T_j = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Conditions	Ratings	Unit
V_{DS}	Drain-Source Voltage	G-S Short	1200	V
V_{GS}	Gate-Source Voltage	D-S Short, AC frequency $\geq 1\text{Hz}$, Note1	-10 to 22	V
I_{DS}	DC Continuous Drain Current	$T_C = 25^\circ\text{C}$, $V_{GS} = +15\text{V}$	450	A
I_{DS}	DC Continuous Drain Current	$T_C = 90^\circ\text{C}$, $V_{GS} = +15\text{V}$	345	A
I_{SD}	Source-Drain Current(diode)	$T_C = 25^\circ\text{C}$, with ON signal	500	A
I_{SD}	Source-Drain Current(diode)	$T_C = 90^\circ\text{C}$, with ON signal	370	A
I_{DSM}	Pulse Drain Current	$T_C = 25^\circ\text{C}$, Pulse width = 1ms, $V_{GS} = +15\text{V}$, Note2	800	A
P_{tot}	Total Power Dissipation	$T_C = 25^\circ\text{C}$	1575	W
T_{jmax}	Max Junction Temperature	-	175	$^\circ\text{C}$
T_{stg}	Storage Temperature	-	-40 to 125	$^\circ\text{C}$

Note1: Recommended Operating Value, +18V/-5V, +15V/-4V

Note2: Pulse width limited by maximum junction temperature

Diode Electrical characteristics ($T_j = 25^\circ\text{C}$ unless otherwise specified, chip)

Symbol	Item	Condition	Value			Unit	
			Min.	Typ.	Max		
V_F	Diode Forward Voltage	$I_F = 360\text{A}$, $V_{GE} = 0\text{V}$	$T_j = 25^\circ\text{C}$	-	1.75	-	V
			$T_j = 150^\circ\text{C}$	-	2.35	-	
t_{rr}	Diode Reverse Recovery Time	(Switch side) $V_{CC} = 600\text{V}$, $I_C = 360\text{A}$	$T_j = 25^\circ\text{C}$	-	26	-	ns
			$T_j = 150^\circ\text{C}$	-	52	-	
I_{RM}	Peak reverse recovery Current	$V_{GE} = +15\text{V}/-4\text{V}$ $R_{gon}/R_{goff} = 3.3\Omega/3.3\Omega$	$T_j = 25^\circ\text{C}$	-	261	-	A
			$T_j = 150^\circ\text{C}$	-	342	-	
Q_{rr}	Recovered charge	(FRD side) $V_{\pi} = 600\text{V}$, $I_F = 360\text{A}$	$T_j = 25^\circ\text{C}$	-	4.5	-	uC
			$T_j = 150^\circ\text{C}$	-	5.8	-	
E_{rr}	Reverse recovered energy	Inductive load switching operation	$T_j = 25^\circ\text{C}$	-	1.1	-	mJ
			$T_j = 150^\circ\text{C}$	-	2.1	-	
$R_{th(j-c)}$	Thermal Resistance, Junction to Case (Diode)		-	0.085	-	$^\circ\text{C}/\text{W}$	

PRXS360HF12DFC1
1200V/360A Half Bridge SiC MOSFET Module

MOSFET Electrical characteristics ($T_j = 25^\circ\text{C}$ unless otherwise specified, chip)

Symbol	Item	Condition	Value			Unit	
			Min.	Typ.	Max		
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=400\mu A$	1200	-	-	V	
I_{DSS}	Zero gate voltage drain Current	$V_{DS}=1200V, V_{GS}=0V$	-	4	-	μA	
$V_{GS(th)}$	Gate-source threshold Voltage	$I_D=140mA, V_{DS}=V_{GS}$	1.8	2.7	-	V	
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=20V, V_{DS}=0V$	-	-	400	nA	
$R_{DS(on)}$ (Chip)	Static drain-source On-state resistance	$I_D=360A$ $V_{GS}=+15V$	$T_j=25^\circ\text{C}$	-	5.3	-	$m\Omega$
			$T_j=175^\circ\text{C}$	-	7.5	-	$m\Omega$
		$I_D=360A$ $V_{GS}=+18V$	$T_j=25^\circ\text{C}$	-	4.3	-	$m\Omega$
			$T_j=175^\circ\text{C}$	-	6.4	-	$m\Omega$
$V_{DS(on)}$ (Chip)	Static drain-source On-state Voltage	$I_D=360A$ $V_{GS}=+15V$	$T_j=25^\circ\text{C}$	-	1.91	-	V
			$T_j=175^\circ\text{C}$	-	2.70	-	V
		$I_D=360A$ $V_{GS}=+18V$	$T_j=25^\circ\text{C}$	-	1.55	-	V
			$T_j=175^\circ\text{C}$	-	2.30	-	V
C_{iss}	Input Capacitance	$V_D=800V, V_{GS}=0V,$ $f=100kHz, V_{AC}=25mV$	-	23.3	-	nF	
C_{oss}	Output Capacitance		-	0.70	-	nF	
C_{rss}	Reverse transfer Capacitance		-	57	-	pF	
R_{Gint}	Internal gate resistor	$f=100kHz, V_{AC}=25mV$	-	0.5	-	Ω	
Q_g	Total gate charge	$V_{DD}=800V, I_D=360A, V_{GS}=+15/-4V$	-	750	-	nC	
$t_{d(on)}$	Turn-on delay time	$V_{DD}=600V$ $I_D=360A$ $V_{GS}=+15/-4V$ $R_{gon}/R_{goff}=3.3\Omega/3.3\Omega$ Inductive load switching operation	$T_j=25^\circ\text{C}$	-	56	-	ns
			$T_j=150^\circ\text{C}$	-	49	-	
t_r	Rise time		$T_j=25^\circ\text{C}$	-	33	-	ns
			$T_j=150^\circ\text{C}$	-	27	-	
$t_{d(off)}$	Turn-off delay time		$T_j=25^\circ\text{C}$	-	119	-	ns
			$T_j=150^\circ\text{C}$	-	131	-	
t_f	Fall time		$T_j=25^\circ\text{C}$	-	37	-	ns
			$T_j=150^\circ\text{C}$	-	48	-	
E_{on}	Turn-on power dissipation		$T_j=25^\circ\text{C}$	-	7.1	-	mJ
			$T_j=150^\circ\text{C}$	-	6.6	-	
E_{off}	Turn-off power dissipation	$T_j=25^\circ\text{C}$	-	5.6	-	mJ	
		$T_j=150^\circ\text{C}$	-	6.1	-		
$R_{th(j-c)}$	FET Thermal Resistance	Junction to Case	-	0.095	-	$^\circ\text{C}/\text{W}$	

PRXS360HF12DFC1
1200V/360A Half Bridge SiC MOSFET Module

Test Conditions

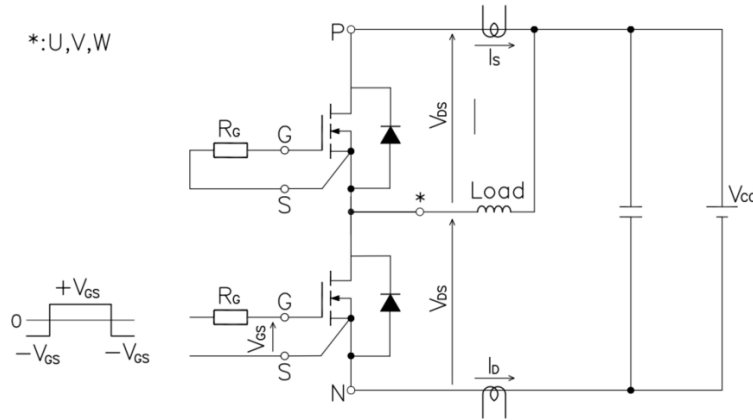


Figure 3. Switching time measure circuit

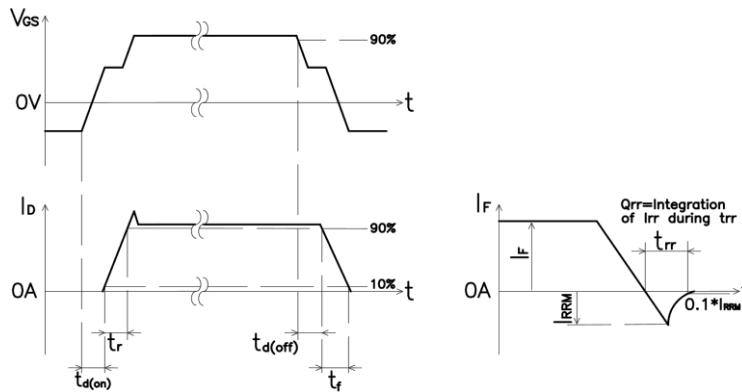


Figure 4. Switching time definition

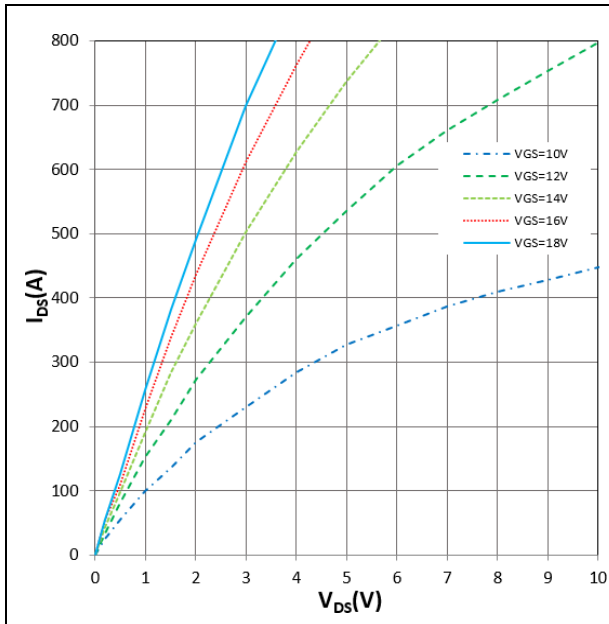


Figure 5. I_{DS} vs V_{DS}
 $T_j=25^\circ\text{C}$

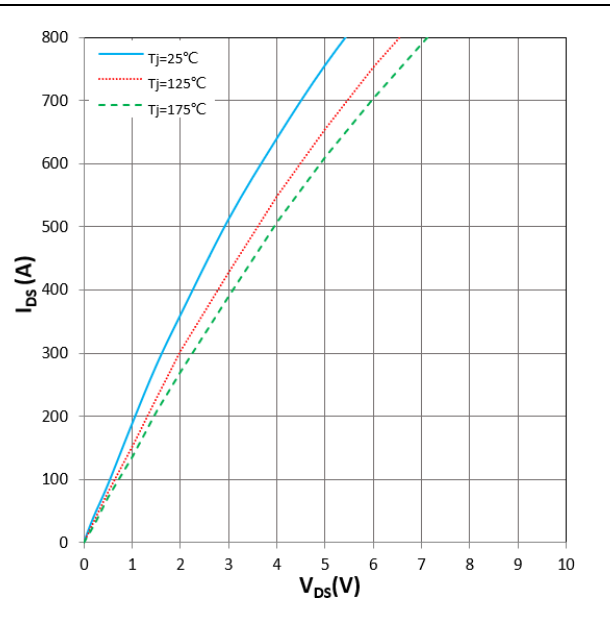


Figure 6. I_{DS} vs V_{DS}
 $V_{GS} = +15\text{V}$

PRXS360HF12DFC1
1200V/360A Half Bridge SiC MOSFET Module

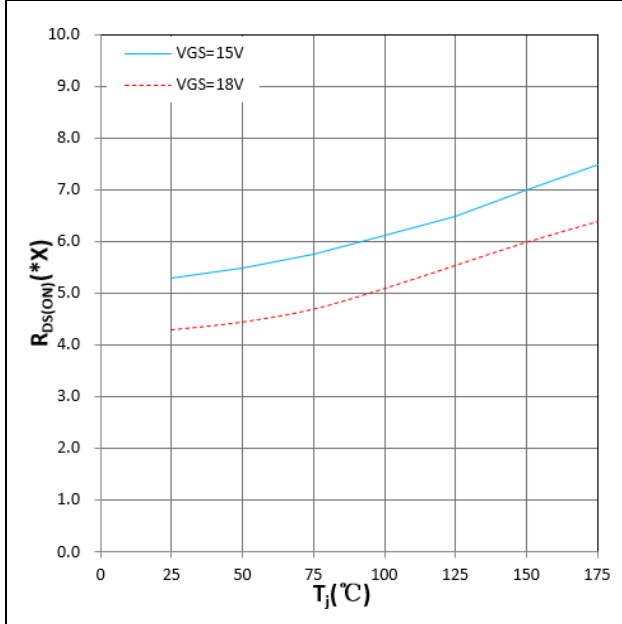


Figure 7. R_{DS(ON)} vs T_j
V_{GS} = +15V/+18V, I_D = 360A

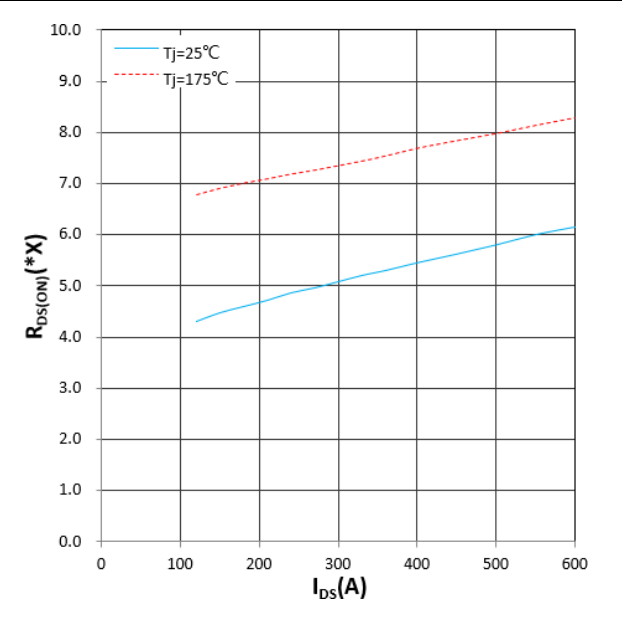


Figure 8. R_{DS(ON)} vs I_{DS}
V_{GS} = +15V, I_D = 360A, T_j = 25°C/175°C

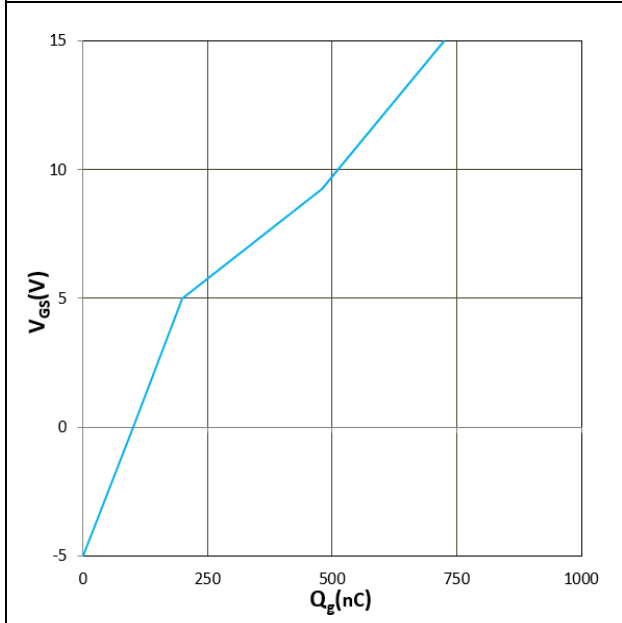


Figure 9. V_{GS} vs Q_g
V_{DS} = 800V, I_D = 240A, T_j = 25°C

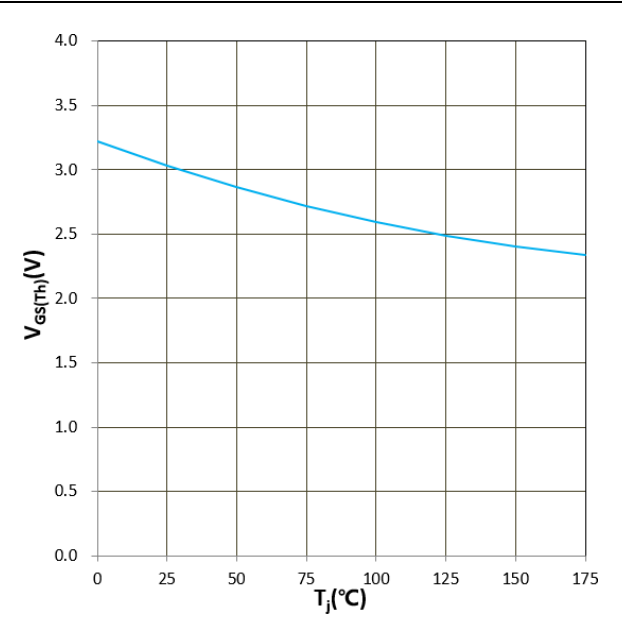


Figure 10. V_{GS(TH)} vs T_j
V_{GS} = V_{DS}, I_D = 140mA

PRXS360HF12DFC1
1200V/360A Half Bridge SiC MOSFET Module

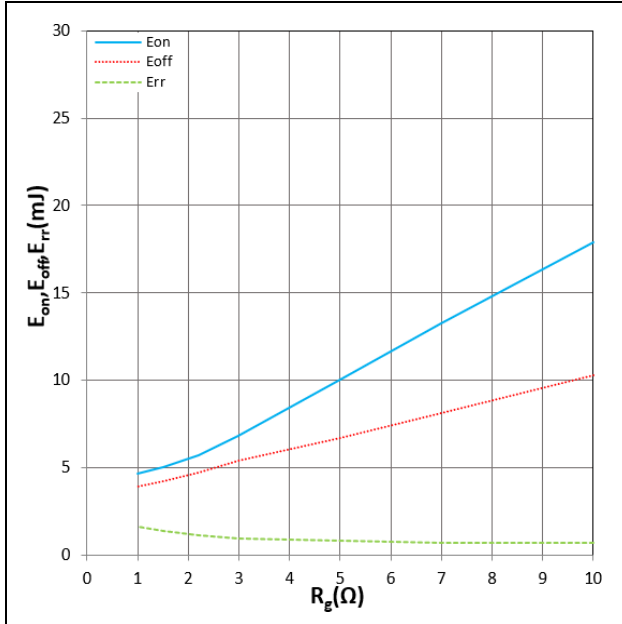


Figure 11. E_{on} , E_{off} , E_{rr} vs R_g
 $T_j=25^\circ\text{C}$, $V_{CC}=600\text{V}$, $V_{GS}=+15\text{V}/-4\text{V}$, $I_D=360\text{A}$
 Inductive Load

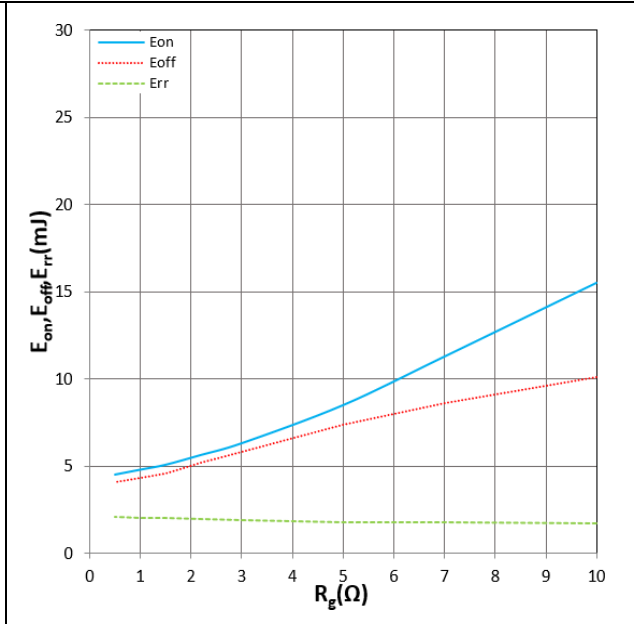


Figure 12. E_{on} , E_{off} , E_{rr} vs R_g
 $T_j=150^\circ\text{C}$, $V_{CC}=600\text{V}$, $V_{GS}=+15\text{V}/-4\text{V}$, $I_D=360\text{A}$
 Inductive Load

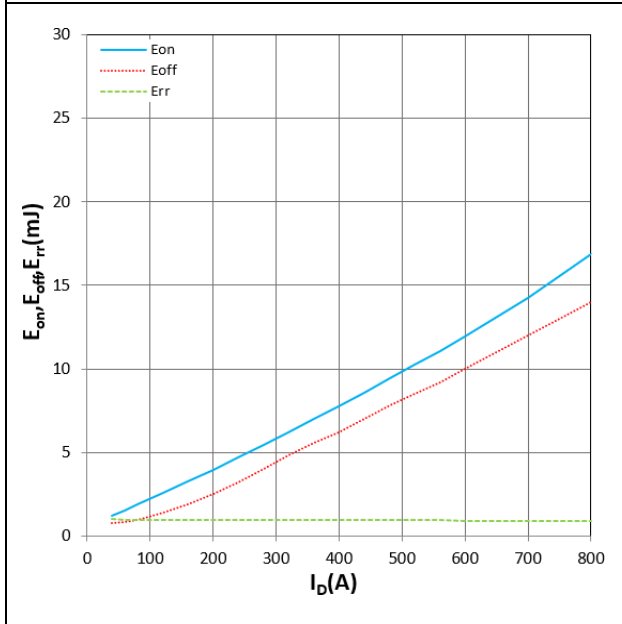


Figure 13. E_{on} , E_{off} , E_{rr} vs I_{Ds}
 $T_j=25^\circ\text{C}$, $V_{CC}=600\text{V}$, $V_{GS}=+15\text{V}/-4\text{V}$
 $R_{gon}/R_{goff}=3.3\Omega/3.3\Omega$, Inductive Load

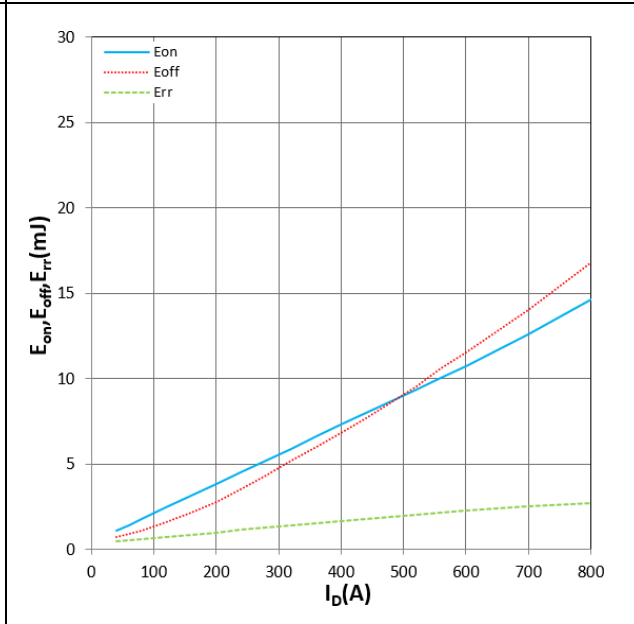


Figure 14. E_{on} , E_{off} , E_{rr} vs I_{Ds}
 $T_j=150^\circ\text{C}$, $V_{CC}=600\text{V}$, $V_{GS}=+15\text{V}/-4\text{V}$
 $R_{gon}/R_{goff}=3.3\Omega/3.3\Omega$, Inductive Load

PRXS360HF12DFC1
1200V/360A Half Bridge SiC MOSFET Module

